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Part Number:	**0768710005**
Status:	**Active**
Overview:	QSFP+ Interconnect Solution
Description:	Quad Small Form-factor Pluggable Plus (QSFP) Assembly, Stacked 2 by 1 with Elastomer Gaskets, Tin

Documents:
3D Model	Application Specification AS-76870-001 (PDF)
Drawing (PDF)	Application Specification AS-76871-0002 (PDF)
Product Specification PS-76870-001 (PDF)	RoHS Certificate of Compliance (PDF)

Series image - Reference only

Agency Certification
UL	E29179

General
Product Family	I/O Connectors
Series	76871
Application	Module-to-Board
Component Type	Receptacle
Electrical Model	Yes
Overview	QSFP+ Interconnect Solution
Product Name	QSFP
Type	N/A
UPC	884982637207

Physical
Boot Color	N/A
Circuits (Loaded)	76
Circuits (maximum)	76
Circuits Detail	76
Durability (mating cycles max)	100
Flammability	94V-0
Gender	Female
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Net Weight	39.492/g
Number of Rows	2
Orientation	Right Angle
PC Tail Length	1.25mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
Packaging Type	Tray
Panel Mount	No
Pitch - Mating Interface	0.80mm
Pitch - Termination Interface	0.80mm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	2
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole - Compliant Pin
Waterproof / Dustproof	No

EU ELV
Not Relevant

EU RoHS	**China RoHS**
Compliant	

REACH SVHC
Not Contained Per
-ED/79/2015 (17
December 2015)

Halogen-Free
Status
Low-Halogen

Need more information on product environmental compliance?

Email productcompliance@molex.com
Please visit the Contact Us section for any non-product compliance questions.

China ROHS	Green Image
ELV	Not Relevant

Search Parts in this Series
76871 Series

Use With
74757 , 74758

Application Tooling | **FAQ**
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.
Global

Description	**Product #**
QSFP+ and zQSFP+ Multi-Port Connector Tooling	0622025300
Multi-Port Connector Extraction Tool	0622030390

Electrical

Current - Maximum per Contact	0.5A
Grounding to Panel	None
Shield Type	EMI Gasket
Shielded	Yes
Voltage - Maximum	120V AC (RMS)/DC

Solder Process Data

Lead-freeProcess Capability	N/A

Material Info

Reference - Drawing Numbers

Application Specification	AS-76870-001, AS-76871-0002
Electrical Model Document	EE-76870-001
Product Specification	PS-76870-001
S-Parameter Model	SP-76870-001
Sales Drawing	SD-76871-001

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